

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested classification::
Suggested Group Art Unit::
CD-ROM or CD-R?: None
Title:: Chip scale package with flip chip interconnect
Attorney Docket Number:: CPAC 1008-2 US
Request for Early Publication?: No
Request for Non-Publication?: No
Suggested Drawing Figure::
Total Drawing Sheets::
Small Entity?: No
Petition included?: No
Secrecy Order in Parent Appl.?: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Rajendra
Family Name:: PENDSE
City of Residence:: Fremont
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 5245 Diamond Common
City of mailing address:: Fremont
State or Province of mailing address:: CA

Country of mailing address:: US
Postal or Zip Code of mailing address:: 94555

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Nazir
Family Name:: AHMAD
City of Residence:: San Jose
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 739 Seawood Way
City of mailing address:: San Jose
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95120

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Andrea
Family Name:: CHEN
City of Residence:: San Jose
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 6923 Chantel Court
City of mailing address:: San Jose
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95129

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Applicant Authority Type:: Inventor
Primary Citizenship Country:: Republic of Korea
Status:: Full Capacity
Given Name:: Kyung-Moon
Family Name:: KIM
City of Residence:: Ichon-si
State or Province of Residence:: Kyoung ki-do
Country of Residence:: Republic of Korea
Street of mailing address:: 312-1 Sadong-ri, Daeyeul-myun
Samjin Apt., 1-301
City of mailing address:: Ichon-si
State or Province of mailing address:: Kyoung ki-do
Country of mailing address:: Republic of Korea
Postal or Zip Code of mailing address:: 467-850

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Young-Do
Family Name:: KWEON
City of Residence:: Cupertino
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 20200 Lucille Avenue, #111
City of mailing address:: Cupertino
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95014

Applicant Authority Type:: Inventor
 Primary Citizenship Country:: US
 Status:: Full Capacity
 Given Name:: Samuel
 Family Name:: TAM
 City of Residence:: Daly City
 State or Province of Residence:: CA
 Country of Residence:: US
 Street of mailing address:: 102 Ashland Drive
 City of mailing address:: Daly City
 State or Province of mailing address:: CA
 Country of mailing address:: US
 Postal or Zip Code of mailing address:: 94015

Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Non-Provisional of	60/272,237	02/27/01

Assignee Information

Assignee name:: ChipPAC, Inc.
Street of mailing address:: 47400 Kato Road
City of mailing address:: Fremont
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 94538

ChipPAC, Inc.
47400 Kato Road
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